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Part Number: Status: Overview: Description:	<mark>0855085001</mark> Active <u>Magnetic and Modular Jacks/Plugs</u> Modular Jack, Cat5e, Vertical,Top Entry, Through Hole, 8/8, Shielded, Tray		Series image - Reference only	
Documents: <u>3D Model</u> <u>3D Model (PDF)</u> <u>Drawing (PDF)</u> <u>Product Specification PS-85508-001-001 (PDF)</u>		Application Specification AS-85513-001-001 (PDF) Packaging Specification PK-95123-001 (PDF) RoHS Certificate of Compliance (PDF) Product Literature (PDF)		
Agency Certificat	tion	E107635	EUELV	
General Product Family Series Comments Component Type		Modular Jacks/Plugs <u>85508</u> Reflow Capable, External Shield PCB Jack	Not RelevantEU RoHSChina RoHSCompliantREACH SVHCNot Contained Per -	
Magnetic Overview Performance Cate Power over Etherr		No <u>Magnetic and Modular Jacks/Plugs</u> 5e N/A	D(2020)9139-DC (19 Jan 2021) <u>Halogen-Free</u> <u>Status</u>	
Product Name UPC		Modular Jack 8/8, RJ45 822350902779	Not Low-Halogen For more information, please visit Contact	
Physical Boot Color Color - Resin Durability (mating Flammability	cycles max)	N/A Black 2500 94V-0	China ROHSGreen ImageELVNot RelevantRoHS PhthalatesNot Contained	
Inverted / Top Latch Jack Height Lightpipes/LEDs		No 16.50mm None	Search Parts in this Series 85508 Series	
Material - Metal Material - Plating Material - Plating	•	Phosphor Bronze Gold over Palladium Nickel Tin	Mates With 95043 Modular Plug, Short Body	
Material - Resin Net Weight Orientation PCB Locator		High Temperature Thermoplastic 6.504/g Vertical (Top Entry) Yes		
PCB Retention PCB Thickness - F Packaging Type	Recommended	Yes 1.57mm Tray		
Pitch - Mating Inte Pitch - Termination Plating min - Matir	n Interface	1.02mm 1.27mm 0.051µm, 1.016µm		
Plating min - Term Port Configuration Positions / Loaded	ination	1.905μm 1x1 8/8		
Surface Mount Co Temperature Rang Termination Interfa	ge - Operating	No -40° to +85°C Through Hole		
Waterproof / Dust		No N/A		

N/A

Electrical

Wire/Cable Type

Current - Maximum per Contact Grounding to PCB Shielded Voltage - Maximum	1.5A Yes Yes 125V DC			
Solder Process Data Duration at Max. Process Temperature (seconds) Lead-freeProcess Capability Max. Cycles at Max. Process Temperature Process Temperature max. C	003 WAVE 001 260			
Material Info				
Reference - Drawing Numbers Application Specification Packaging Specification	AS-85513-001-001 PK-95123-001			

Product Specification

Sales Drawing

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PS-85508-001-001

SD-85508-501